

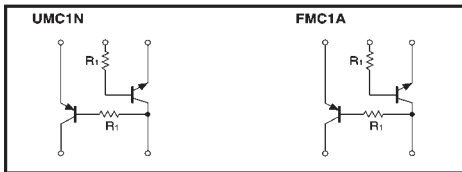
Power management (dual digital transistors)

UMC1N / FMC1A

●Features

1) Both the DTA143T chip and DTC143T chip in a UMT or SMT package.

●Circuit diagrams



●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV_{CBO}	50	—	—	V	$I_C=50/-50\text{ }\mu\text{A}$
Collector-emitter breakdown voltage	BV_{CEO}	50	—	—	V	$I_C=1/-1\text{mA}$
Emitter-base breakdown voltage	BV_{EBO}	5	—	—	V	$I_E=50/-50\text{ }\mu\text{A}$
Collector cutoff current	I_{CBO}	—	—	0.5	μA	$V_{CB}=50/-50\text{V}$
Emitter cutoff current	I_{EBO}	—	—	0.5	μA	$V_{EB}=4/-4\text{V}$
Collector-emitter saturation voltage	$V_{CE(sat)}$	—	—	0.3	V	$I_C=5/-5\text{mA}$, $I_B=0.25/-0.25\text{mA}$
DC current transfer ratio	h_{FE}	100	250	600	—	$V_{CE}=5/-5\text{V}$, $I_C=1/-1\text{mA}$
Transition frequency	f_T	—	250	—	MHz	$V_{CE}=10\text{V}$, $F_E=-5\text{mA}$, $f=100\text{MHz}$
Input resistance	R_1	3.29	4.7	6.11	k Ω	—

●Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit	
Collector-base voltage		V_{CBO}	50	V	
Collector-emitter voltage		V_{CEO}	50	V	
Emitter-base voltage		V_{EBO}	5	V	
Collector current		I_c	100	mA	
Collector power dissipation	UMC1N	P_d	150 (TOTAL)	mW	*1
	FMC1A		300 (TOTAL)		*2
Junction temperature		T_j	150	°C	
Storage temperature		T_{stg}	-55~+150	°C	

*1 120mW per element must not be exceeded. *2 200mW per element must not be exceeded. PNP type negative symbols have been omitted.

●Package, marking, and packaging specifications

Part No.	UMC1N	FMC1A
Package	UMT5	SMT5
Marking	C1	C1
Code	TR	T148
Basic ordering unit (pieces)	3000	3000